



DOCKET: 2760

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application: Dong Suk SHIN

Serial No.: 10/034,243

Filed: December 28, 2001

For: METHOD OF FABRICATING A
SEMICONDUCTOR DEVICE HAVING
REDUCED CONTACT RESISTANCE

GRP ART UNIT

Ex.

RECEIVED
MAR -3 2002
TO 2000 MAIL ROOM

Certification under 37 C.F.R. §1.8(a)

I hereby certify that this paper (along with any paper referred to as being attached or enclosed) is being deposited with The United States Postal Service with sufficient postage as first class mail in an envelope addressed to The Commissioner for Patents, Washington, D.C. 20231 on February 19, 2002.

Vangelis Economou
Vangelis Economou - Reg. No. 32,341

Commissioner for Patents
Washington, D.C. 20231

**TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT WITHIN THREE MONTHS
OF FILING OR BEFORE MAILING OF FIRST OFFICE ACTION**

Sir:

The information disclosure statement submitted herewith is being filed within three months of the filing date of the application or date of entry into the national stage of an international application or before the mailing date of the first Office Action on the merits, whichever event occurs last. 37 CFR 1.97(b).

February 19, 2002

Vangelis Economou
Vangelis Economou -Reg. No. 32,341
Ladas & Parry
224 South Michigan Avenue
Chicago Illinois 60604
Tel. No. (312) 427-1300

idsb4oa

